BOARD NAME: USB TYPE C DOCK
BOARD REV: 3.0
KSID: 16871
JOB NUMBER: 129072

ALL ARTWORK LAYERS VIEWED FROM TOP

LAYER DESCRIPTION:
SILKSCREEN TOP
**NOT FCC APPROVED FOR RESALE**

**FOR EVALUATION ONLY**

<table>
<thead>
<tr>
<th>BOARD NAME:</th>
<th>BOARD REV:</th>
<th>KSID:</th>
<th>JOB NUMBER:</th>
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<td>USB TYPE C DOCK</td>
<td>3.0</td>
<td>16871</td>
<td>129072</td>
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**ALL ARTWORK LAYERS VIEWED FROM TOP**

**LAYER DESCRIPTION:**

**SILKSCREEN BOTTOM**
BOARD NAME: USB TYPE C DOCK
BOARD REV: 3.0 JSID: 16871
JOB NUMBER: 129072
ALL ARTWORK LAYERS VIEWED FROM TOP
LAYER DESCRIPTION: LAYER 3 - SIG
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<th>BOARD NAME:</th>
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<td>USB TYPE C DOCK</td>
<td>3.0</td>
<td>16871</td>
<td>129072</td>
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</table>

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<tr>
<th>ALL ARTWORK LAYERS VIEWED FROM TOP</th>
<th>LAYER DESCRIPTION:</th>
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</thead>
<tbody>
<tr>
<td>LAYER 5 - PWR</td>
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</table>
BOARD NAME: USB TYPE C DOCK  
BOARD REV: 3.0  
KSID: 16871  
JOB NUMBER: 129072  
ALL ARTWORK LAYERS VIEWED FROM TOP  
LAYER DESCRIPTION: LAYER 8 - SIG
BOARD NAME: USB TYPE C DOCK  
BOARD REV: 3.0  
KSID: 16871  
JOB NUMBER: 129072  

ALL ARTWORK LAYERS VIEWED FROM TOP  
LAYER DESCRIPTION: LAYER 9 - GND PLANE
BOARD NAME: USB TYPE C DOCK
BOARD REV: 3.0
KSID: 16871
JOB NUMBER: 129072

ALL ARTWORK LAYERS VIEWED FROM TOP

LAYER DESCRIPTION:
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